



**AO4803**

**Dual P-Channel Enhancement Mode Field Effect Transistor**

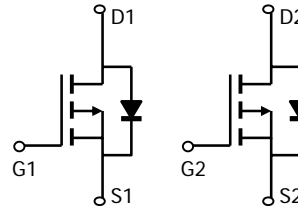
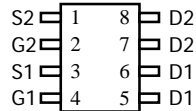
**General Description**

The AO4803 uses advanced trench technology to provide excellent  $R_{DS(ON)}$  with low gate charge. This device is suitable for use as a load switch or in PWM applications. *Standard Product AO4803 is Pb-free (meets ROHS & Sony 259 specifications). AO4803L is a Green Product ordering option. AO4803 and AO4803L are electrically identical.*

**Features**

- $V_{DS} (V) = -30V$
- $I_D = -5 A (V_{GS} = -10V)$
- $R_{DS(ON)} < 52m\Omega (V_{GS} = -10V)$
- $R_{DS(ON)} < 87m\Omega (V_{GS} = -4.5V)$

**SOIC-8  
Top View**



**Absolute Maximum Ratings  $T_A=25^\circ C$  unless otherwise noted**

| Parameter                              | Symbol           | Maximum          | Units      |
|--|------------------|------------------|------------|
| Drain-Source Voltage                   | $V_{DS}$         | -30              | V          |
| Gate-Source Voltage                    | $V_{GS}$         | $\pm 20$         | V          |
| Continuous Drain Current <sup>A</sup>  | $T_A=25^\circ C$ | -5               | A          |
|  |                  | $T_A=70^\circ C$ |            |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$         | -20              |            |
| Power Dissipation <sup>A</sup>         | $T_A=25^\circ C$ | 2                | W          |
|  |                  | $T_A=70^\circ C$ |            |
| Junction and Storage Temperature Range | $T_J, T_{STG}$   | -55 to 150       | $^\circ C$ |

**Thermal Characteristics**

| Parameter                                | Symbol          | Typ          | Max  | Units        |
|--|-----------------|--------------|------|--------------|
| Maximum Junction-to-Ambient <sup>A</sup> | $R_{\theta JA}$ | 48           | 62.5 | $^\circ C/W$ |
| Maximum Junction-to-Ambient <sup>A</sup> |                 | Steady-State | 74   |              |
| Maximum Junction-to-Lead <sup>C</sup>    | $R_{\theta JL}$ | 35           | 40   | $^\circ C/W$ |

Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)

| Symbol                      | Parameter                             | Conditions  | Min | Typ      | Max       | Units         |
|-----------------------------|---------------------------------------|---|-----|----------|-----------|---------------|
| <b>STATIC PARAMETERS</b>    |                                       |   |     |          |           |               |
| $BV_{DSS}$                  | Drain-Source Breakdown Voltage        | $I_D=-250\mu\text{A}, V_{GS}=0\text{V}$                                     | -30 |          |           | V             |
| $I_{DSS}$                   | Zero Gate Voltage Drain Current       | $V_{DS}=-24\text{V}, V_{GS}=0\text{V}$<br>$T_J=55^\circ\text{C}$            |     |          | -1<br>-5  | $\mu\text{A}$ |
| $I_{GSS}$                   | Gate-Body leakage current             | $V_{DS}=0\text{V}, V_{GS}=\pm 20\text{V}$                                   |     |          | $\pm 100$ | nA            |
| $V_{GS(th)}$                | Gate Threshold Voltage                | $V_{DS}=V_{GS}, I_D=-250\mu\text{A}$  | -1  | -1.8     | -3        | V             |
| $I_{D(ON)}$                 | On state drain current                | $V_{GS}=-4.5\text{V}, V_{DS}=-5\text{V}$                                    | -20 |          |           | A             |
| $R_{DS(ON)}$                | Static Drain-Source On-Resistance     | $V_{GS}=-10\text{V}, I_D=5.0\text{A}$<br>$T_J=125^\circ\text{C}$            |     | 39<br>54 | 52<br>70  | m $\Omega$    |
|                             |                                       | $V_{GS}=-4.5\text{V}, I_D=-4\text{A}$                                       |     | 67       | 87        |               |
| $g_{FS}$                    | Forward Transconductance              | $V_{DS}=-5\text{V}, I_D=-5\text{A}$   | 6   | 8.6      |           | S             |
| $V_{SD}$                    | Diode Forward Voltage                 | $I_S=-1\text{A}, V_{GS}=0\text{V}$  |     | -0.77    | -1        | V             |
| $I_S$                       | Maximum Body-Diode Continuous Current |   |     |          | -2.8      | A             |
| <b>DYNAMIC PARAMETERS</b>   |                                       |   |     |          |           |               |
| $C_{iss}$                   | Input Capacitance                     | $V_{GS}=0\text{V}, V_{DS}=-15\text{V}, f=1\text{MHz}$                       |     | 700      |           | pF            |
| $C_{oss}$                   | Output Capacitance                    |   |     | 120      |           | pF            |
| $C_{rss}$                   | Reverse Transfer Capacitance          |   |     | 75       |           | pF            |
| $R_g$                       | Gate resistance                       | $V_{GS}=0\text{V}, V_{DS}=0\text{V}, f=1\text{MHz}$                         |     | 10       |           | $\Omega$      |
| <b>SWITCHING PARAMETERS</b> |                                       |   |     |          |           |               |
| $Q_g(10\text{V})$           | Total Gate Charge (10V)               | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, I_D=-5\text{A}$                    |     | 14.7     |           | nC            |
| $Q_g(4.5\text{V})$          | Total Gate Charge (4.5V)              |   |     | 7.6      |           | nC            |
| $Q_{gs}$                    | Gate Source Charge                    |   |     | 2        |           | nC            |
| $Q_{gd}$                    | Gate Drain Charge                     |   |     | 3.8      |           | nC            |
| $t_{D(on)}$                 | Turn-On Delay Time                    | $V_{GS}=-10\text{V}, V_{DS}=-15\text{V}, R_L=3\Omega,$<br>$R_{GEN}=3\Omega$ |     | 8.3      |           | ns            |
| $t_r$                       | Turn-On Rise Time                     |   |     | 5        |           | ns            |
| $t_{D(off)}$                | Turn-Off Delay Time                   |   |     | 29       |           | ns            |
| $t_f$                       | Turn-Off Fall Time                    |   |     | 14       |           | ns            |
| $t_{rr}$                    | Body Diode Reverse Recovery Time      | $I_F=-5\text{A}, dI/dt=100\text{A}/\mu\text{s}$                             |     | 23.5     |           | ns            |
| $Q_{rr}$                    | Body Diode Reverse Recovery Charge    | $I_F=-5\text{A}, dI/dt=100\text{A}/\mu\text{s}$                             |     | 13.4     |           | nC            |

A: The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The value in any given application depends on the user's specific board design. The current rating is based on the  $t \leq 10\text{s}$  thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C: The  $R_{\theta JA}$  is the sum of the thermal impedance from junction to lead  $R_{\theta JL}$  and lead to ambient.

D: The static characteristics in Figures 1 to 6, 12, 14 are obtained using 80 $\mu\text{s}$  pulses, duty cycle 0.5% max.

E: These tests are performed with the device mounted on 1 in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A=25^\circ\text{C}$ . The SOA curve provides a single pulse rating.

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TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

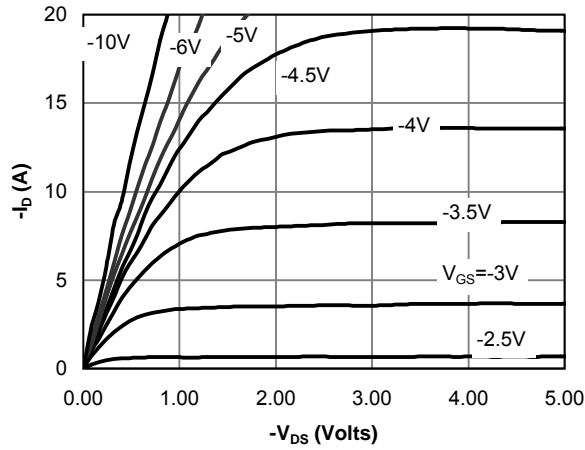


Figure 1: On-Region Characteristics

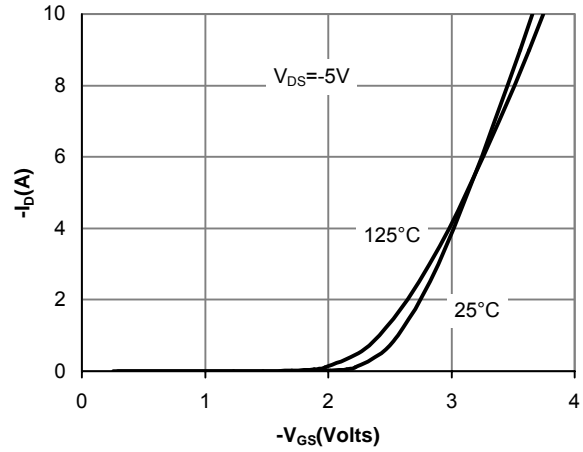


Figure 2: Transfer Characteristics

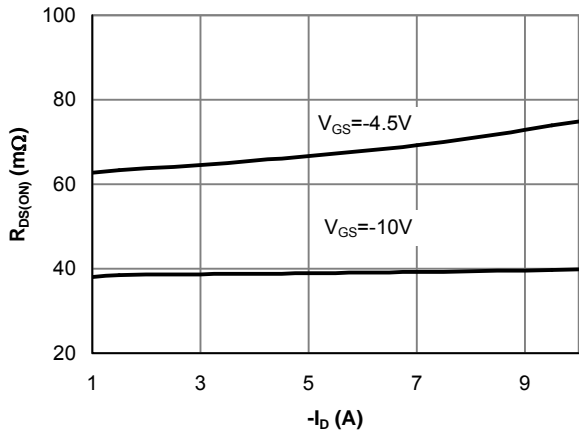


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

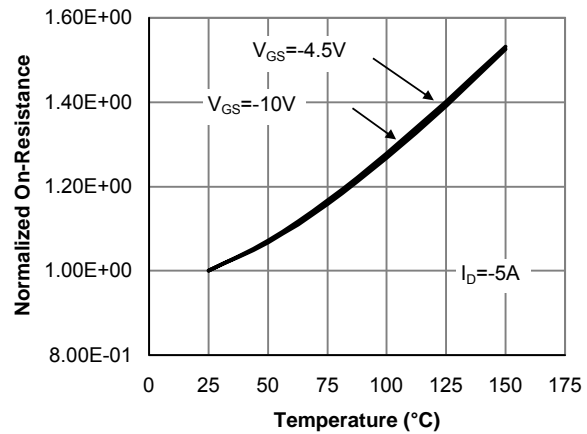


Figure 4: On-Resistance vs. Junction Temperature

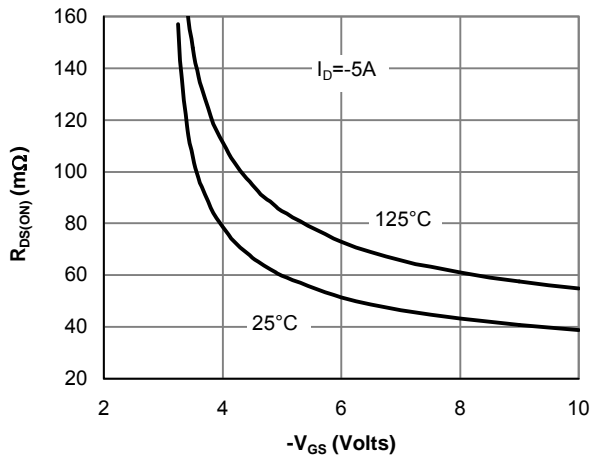


Figure 5: On-Resistance vs. Gate-Source Voltage

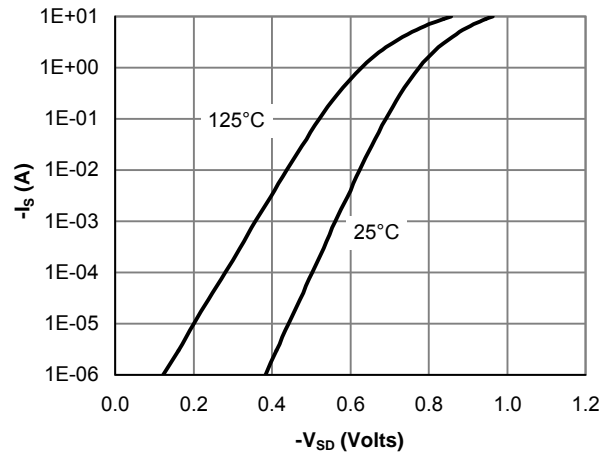


Figure 6: Body-Diode Characteristics

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

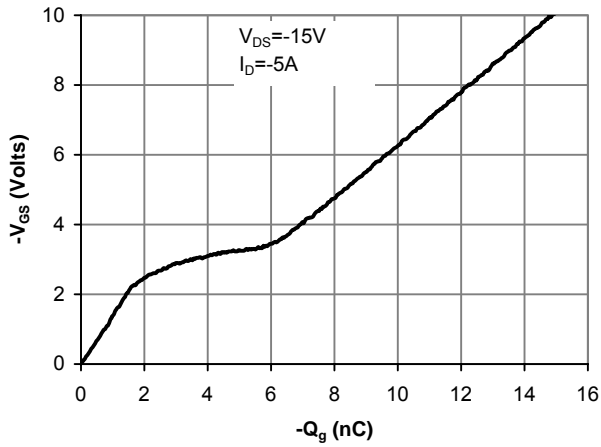


Figure 7: Gate-Charge Characteristics

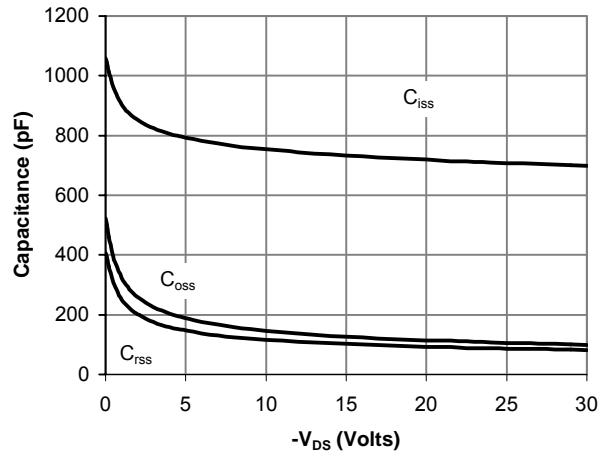


Figure 8: Capacitance Characteristics

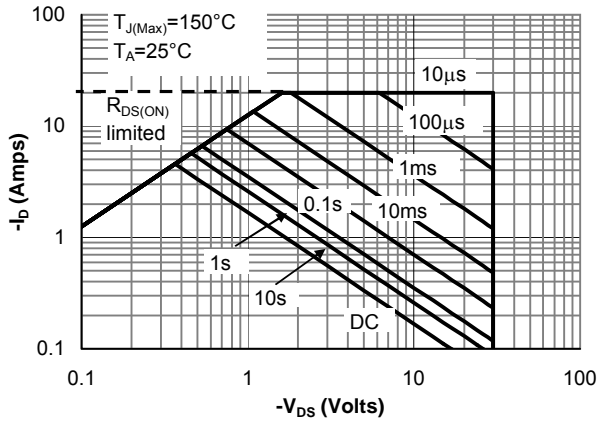


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

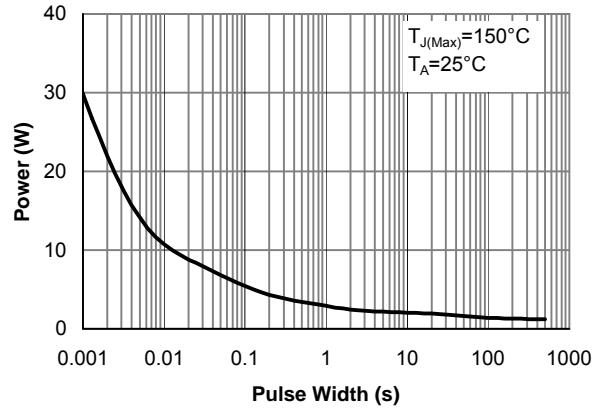


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

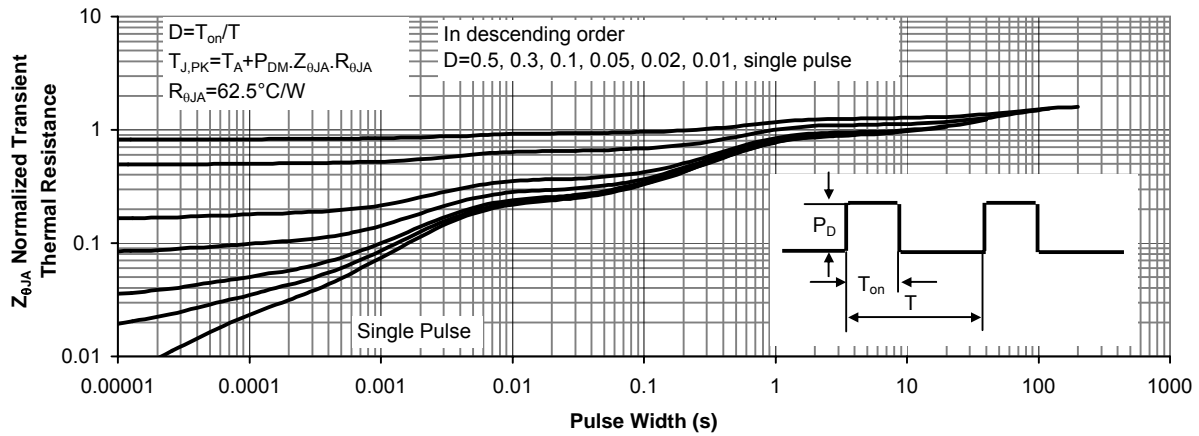


Figure 11: Normalized Maximum Transient Thermal Impedance